



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Wing-Cheong Gilbert Lai et al.

Title: SMALL GRAIN SIZE, CONFORMAL ALUMINUM INTERCONNECTS AND METHOD FOR THEIR FORMATION

Docket No.: 303.261US3

Serial No.: 09/782,498

Filed: February 13, 2001

Due Date: February 20, 2003

Examiner: Tuan Quach

Group Art Unit: 2814

Commissioner for Patents
Washington, D.C. 20231

We are transmitting herewith the following attached items (as indicated with an "X"):

- ☒ A return postcard.
- ☒ An Amendment and Response (5 Pages).
- ☒ A Clean Version of Pending Claims (6 pgs.).

Please consider this a **PETITION FOR EXTENSION OF TIME** for sufficient number of months to enter these papers and please charge any additional required fees or credit overpayment to Deposit Account No. 19-0743.

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on this 20 day of February, 2003.

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